# **MA2Q737** (MA737)

# Silicon epitaxial planar type

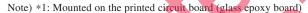
### For high frequency rectification

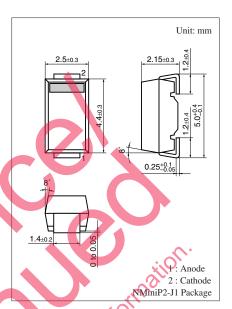
#### ■ Features

- Forward current (Average)  $I_{F(AV)} = 1.5$  A rectification is possible
- Reverse voltage  $V_R = 30 \text{ V}$  is guaranteed
- Automatic insertion with the emboss taping is possible

# ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	$V_R$	30	V	
Repetitive peak reverse voltage	V <sub>RRM</sub>	30	y	
Forward current (Average) *1	I <sub>F(AV)</sub>	1.5	A	
Non-repetitive peak forward surge current *2	I <sub>FSM</sub>	60	A	
Junction temperature	Tj	-40 to +125	°C	
Storage temperature	T <sub>stg</sub>	-40 to +125	°C /	



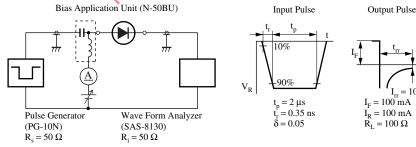


Marking Symbol: PC

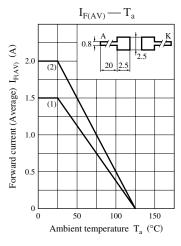
# ■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

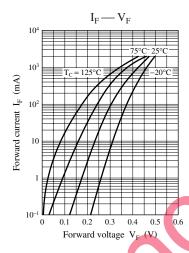
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Junction temperature	$T_{j}$	-40 to +125	°C	Marking Symbol: PC							
Storage temperature	T <sub>stg</sub> -40 to +125 °C										
Storage temperature  T <sub>stg</sub> -40 to +125  C  Note) *1: Mounted on the printed circuit board (glass epoxy board)  *2: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)											
*2: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)											
out iso											
■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$											
Parameter	Symb	ol	Conditions	die	Min	Тур	Max	Unit			
Forward voltage	$V_{\rm F}$	$I_F = 2$ .	0 A	S			0.50	V			
Reverse current	$I_R$ $V_R = 30 \text{ V}$				1	mA					
Terminal capacitance	$V_R = 10 \text{ W, } f = 1 \text{ MHz}$			70		pF					
Reverse recovery time *	t <sub>rr</sub>	$t_{rr}$ $I_F = I_R = 100 \text{ mA}$				50	ns				
		$I_{rr} = 10$	$0 \text{ mA} R_{L} = 100 \Omega$								

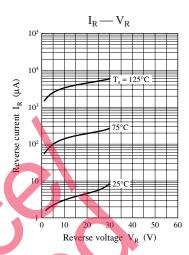
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
  - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
  - 3. Absolute frequency of input and output is 20 MHz.
  - 4. \*: t<sub>rr</sub> measurement circuit



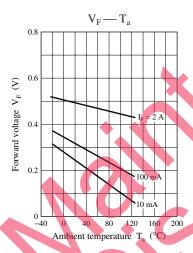
Note) The part number in the parenthesis shows conventional part number.

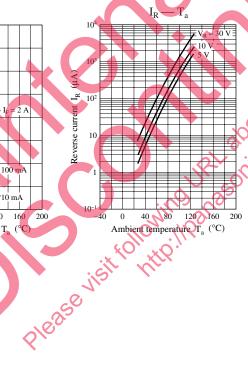


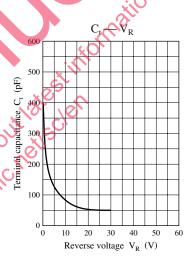




- (1) Printed circuit board: Glass Epoxy PC board (2) Printed circuit board: Alumina PC board Copper foil: Both A and K sides
- $2.5 \text{ mm} \times 2.5 \text{ mm} + 0.8 \text{ mm} \times 20 \text{ mm}$







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